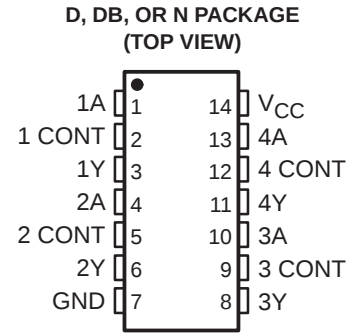


# SN75C189, SN75C189A QUADRUPLE LOW-POWER LINE RECEIVERS

SLLS041G – OCTOBER 1988 – REVISED JANUARY 2000

- Meet or Exceed the Requirements of TIA/EIA-232-F and ITU Recommendation V.28
- Low Supply Current . . . 420  $\mu$ A Typ
- Preset On-Chip Input Noise Filter
- Built-in Input Hysteresis
- Response and Threshold Control Inputs
- Push-Pull Outputs
- Functionally Interchangeable and Pin-to-Pin Compatible With Texas Instruments SN75189/SN75189A and Motorola MC1489/MC1489A
- Package Options Include Plastic Small-Outline (D) and Shrink Small-Outline (DB) Packages, and Standard Plastic (N) DIP



## description

The SN75C189 and SN75C189A are low-power, bipolar, quadruple line receivers that are used to interface data terminal equipment (DTE) with data circuit-terminating equipment (DCE). These devices have been designed to conform to TIA/EIA-232-F.

The SN75C189 has a 0.33-V typical hysteresis, compared with 0.97 V for the SN75C189A. Each receiver has provision for adjustment of the overall input threshold levels. This is achieved by choosing external series resistors and voltages to provide bias levels for the response-control pins. The output is in the high logic state if the input is open circuit or shorted to ground.

These devices have an on-chip filter that rejects input pulses of less than 1- $\mu$ s duration. An external capacitor can be connected from the control pins to ground to provide further input noise filtering for each receiver.

The SN75C189 and SN75C189A have been designed using low-power techniques in a bipolar technology. In most applications, these receivers interface to single inputs of peripheral devices such as UARTs, ACEs, or microprocessors. By using sampling, such peripheral devices usually are insensitive to the transition times of the input signals. If this is not the case, or for other uses, it is recommended that the SN75C189 and SN75C189A outputs be buffered by single Schmitt input gates or single gates of the HCMOS, ALS, or 74F logic families.

The SN75C189 and SN75C189A are characterized for operation from 0°C to 70°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

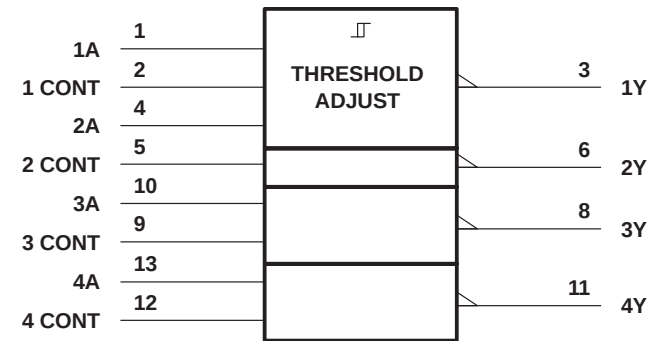
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SN75C189, SN75C189A  
QUADRUPLE LOW-POWER LINE RECEIVERS

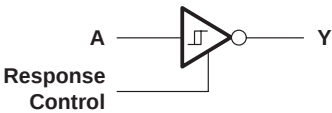
SLLS041G – OCTOBER 1988 – REVISED JANUARY 2000

logic symbol†

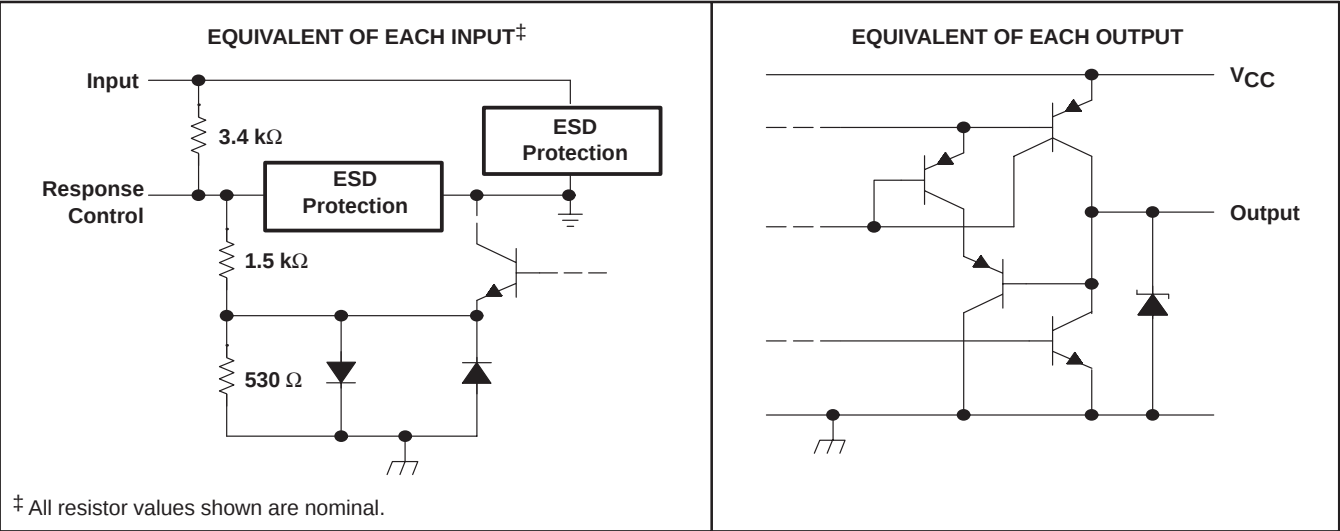


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (each receiver)



schematic of inputs and outputs



‡ All resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)§

|                                                                  |                            |
|------------------------------------------------------------------|----------------------------|
| Supply voltage, $V_{CC}$ (see Note 1)                            | 7 V                        |
| Input voltage range, $V_I$                                       | -30 V to 30 V              |
| Output voltage range, $V_O$                                      | -0.3 V to $V_{CC} + 0.3$ V |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): D package | 86°C/W                     |
| DB package                                                       | 96°C/W                     |
| N package                                                        | 80°C/W                     |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds     | 260°C                      |
| Storage temperature range, $T_{stg}$                             | -65°C to 150°C             |

§ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to network GND.  
2. The package thermal impedance is calculated in accordance with JESD 51.

# SN75C189, SN75C189A QUADRUPLE LOW-POWER LINE RECEIVERS

SLLS041G – OCTOBER 1988 – REVISED JANUARY 2000

## recommended operating conditions

|                                               | MIN | NOM | MAX  | UNIT |
|-----------------------------------------------|-----|-----|------|------|
| V <sub>CC</sub> Supply voltage                | 4.5 | 5   | 6    | V    |
| V <sub>I</sub> Input voltage (see Note 3)     | –25 |     | 25   | V    |
| I <sub>OH</sub> High-level output current     |     |     | –3.2 | mA   |
| I <sub>OL</sub> Low-level output current      |     |     | 3.2  | mA   |
| Response-control current                      |     |     | ±1   | mA   |
| T <sub>A</sub> Operating free-air temperature | 0   |     | 70   | °C   |

NOTE 3: The algebraic convention, where the more positive (less negative) limit is designated as maximum, is used in this data sheet for logic levels only, e.g., if –10 V is a maximum, the typical value is a more negative voltage.

## electrical characteristics over recommended free-air temperature range, V<sub>CC</sub> = 5 V ±10% (unless otherwise noted) (see Note 4)

| PARAMETER                                                                        | TEST CONDITIONS                                                                    | MIN                    | TYP <sup>†</sup> | MAX  | UNIT |
|----------------------------------------------------------------------------------|------------------------------------------------------------------------------------|------------------------|------------------|------|------|
| V <sub>IT+</sub> Positive-going input threshold voltage                          | See Figure 1                                                                       | 1                      |                  | 1.5  | V    |
| V <sub>IT–</sub> Negative-going input threshold voltage                          | See Figure 1                                                                       | 0.75                   |                  | 1.25 | V    |
| V <sub>hys</sub> Input hysteresis voltage (V <sub>IT+</sub> – V <sub>IT–</sub> ) | See Figure 1                                                                       | 0.15                   | 0.33             |      | V    |
| V <sub>OH</sub> High-level output voltage                                        | V <sub>CC</sub> = 4.5 V to 6 V, V <sub>I</sub> = 0.75 V, I <sub>OH</sub> = –20 µA  | 3.5                    |                  |      | V    |
|                                                                                  | V <sub>CC</sub> = 4.5 V to 6 V, V <sub>I</sub> = 0.75 V, I <sub>OH</sub> = –3.2 mA | 2.5                    |                  |      | V    |
| V <sub>OL</sub> Low-level output voltage                                         | V <sub>CC</sub> = 4.5 V to 6 V, V <sub>I</sub> = 3 V, I <sub>OL</sub> = 3.2 mA     |                        |                  | 0.4  | V    |
| I <sub>IH</sub> High-level input current                                         | See Figure 2                                                                       | V <sub>I</sub> = 25 V  | 3.6              | 8.3  | mA   |
|                                                                                  |                                                                                    | V <sub>I</sub> = 3 V   | 0.43             | 1    | mA   |
| I <sub>IL</sub> Low-level input current                                          | See Figure 2                                                                       | V <sub>I</sub> = –25 V | –3.6             | –8.3 | mA   |
|                                                                                  |                                                                                    | V <sub>I</sub> = –3 V  | –0.43            | –1   | mA   |
| I <sub>OS</sub> Short-circuit output current                                     | See Figure 3                                                                       |                        |                  | –35  | mA   |
| I <sub>CC</sub> Supply current                                                   | V <sub>I</sub> = 5 V, No load, See Figure 2                                        |                        | 420              | 700  | µA   |

<sup>†</sup> All typical values are at T<sub>A</sub> = 25°C.

NOTE 4: All characteristics are measured with response-control terminal open.

## switching characteristics, V<sub>CC</sub> = 5 V ±10%, T<sub>A</sub> = 25°C

| PARAMETER                                                                  | TEST CONDITIONS                                             | MIN | TYP | MAX | UNIT |
|----------------------------------------------------------------------------|-------------------------------------------------------------|-----|-----|-----|------|
| t <sub>pLH</sub> Propagation delay time, low- to high-level output         | R <sub>L</sub> = 5 kΩ, C <sub>L</sub> = 50 pF, See Figure 4 |     |     | 6   | µs   |
| t <sub>pHL</sub> Propagation delay time, high- to low-level output         |                                                             |     |     | 6   | µs   |
| t <sub>TLH</sub> Transition time, low- to high-level output <sup>‡</sup>   |                                                             |     |     | 500 | ns   |
| t <sub>THL</sub> Transition time, high- to low-level output <sup>‡</sup>   |                                                             |     |     | 300 | ns   |
| t <sub>w(N)</sub> Duration of longest pulse rejected as noise <sup>§</sup> |                                                             | 1   |     | 6   | µs   |

<sup>‡</sup> Measured between 10% and 90% points of output waveform

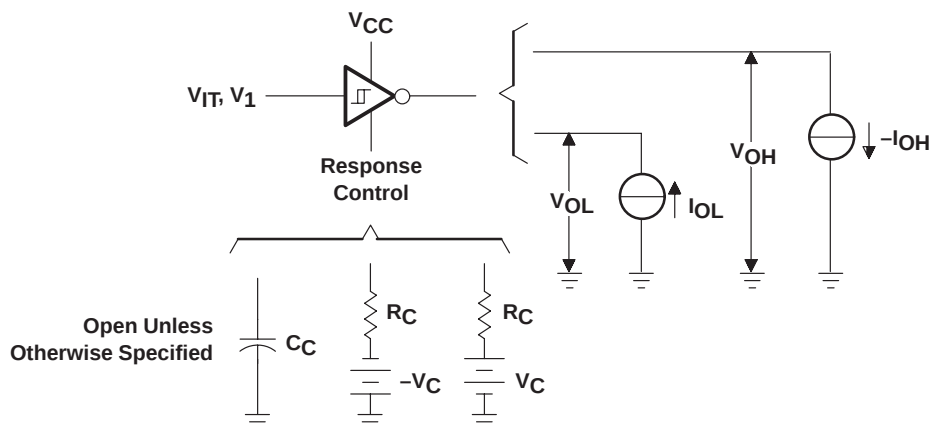
<sup>§</sup> The receiver ignores any positive- or negative-going pulse that is less than the minimum value of t<sub>w(N)</sub> and accepts any positive- or negative-going pulse greater than the maximum of t<sub>w(N)</sub>.



# SN75C189, SN75C189A QUADRUPLE LOW-POWER LINE RECEIVERS

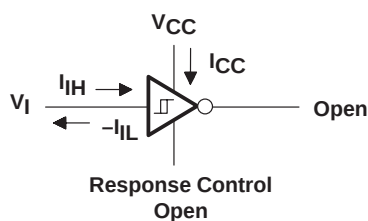
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## PARAMETER MEASUREMENT INFORMATION



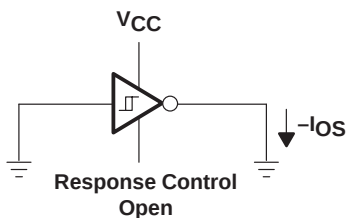
NOTE A: Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

Figure 1.  $V_{T+}$ ,  $V_{IT-}$ ,  $V_{OH}$ ,  $V_{OL}$



NOTE A: Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

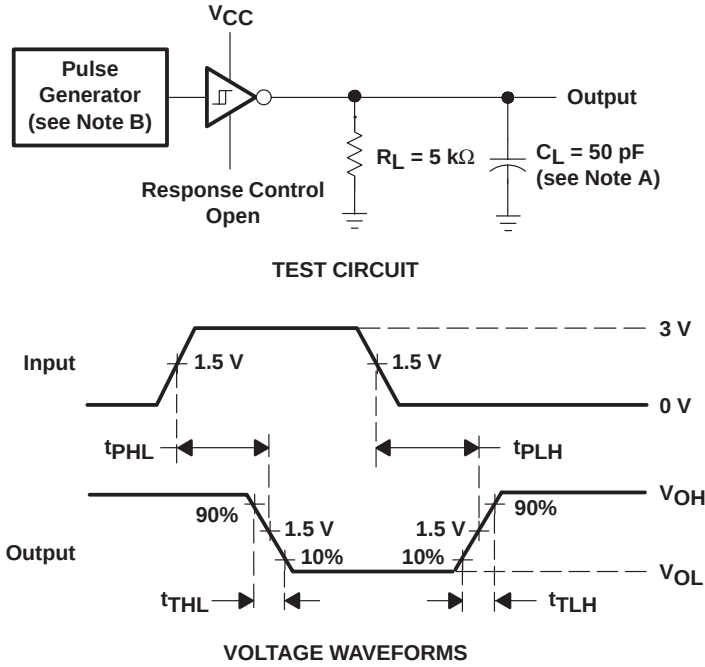
Figure 2.  $I_{IH}$ ,  $I_{IL}$ ,  $I_{CC}$



NOTE A: Arrows indicate actual direction of current flow. Current into a terminal is a positive value.

Figure 3.  $I_{OS}$

## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitances.  
B. The pulse generator has the following characteristics:  $Z_O = 50\text{ }\Omega$ ,  $t_W = 25\text{ }\mu\text{s}$ .

Figure 4. Test Circuit and Voltage Waveforms

SN75C189, SN75C189A  
QUADRUPLE LOW-POWER LINE RECEIVERS

SLLS041G – OCTOBER 1988 – REVISED JANUARY 2000

TYPICAL CHARACTERISTICS

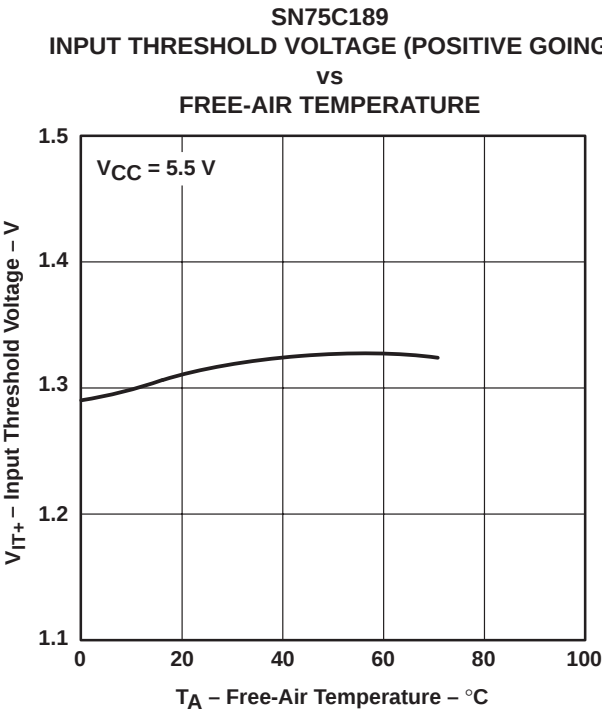


Figure 5

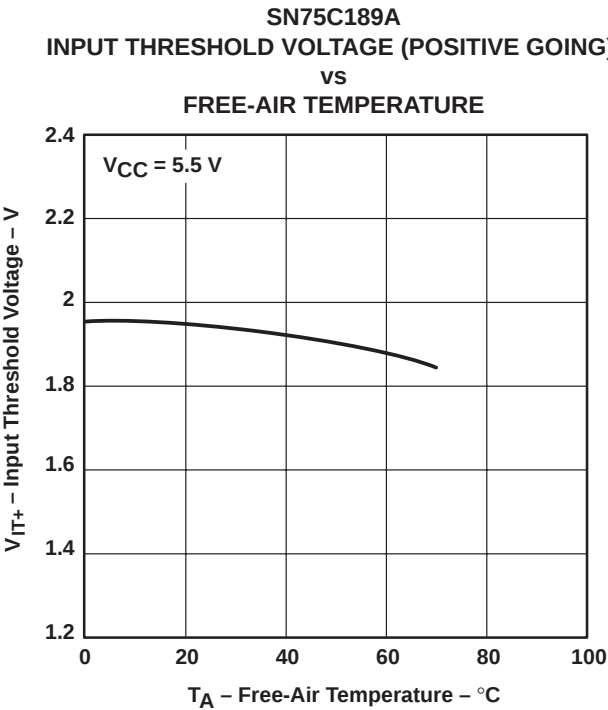


Figure 6

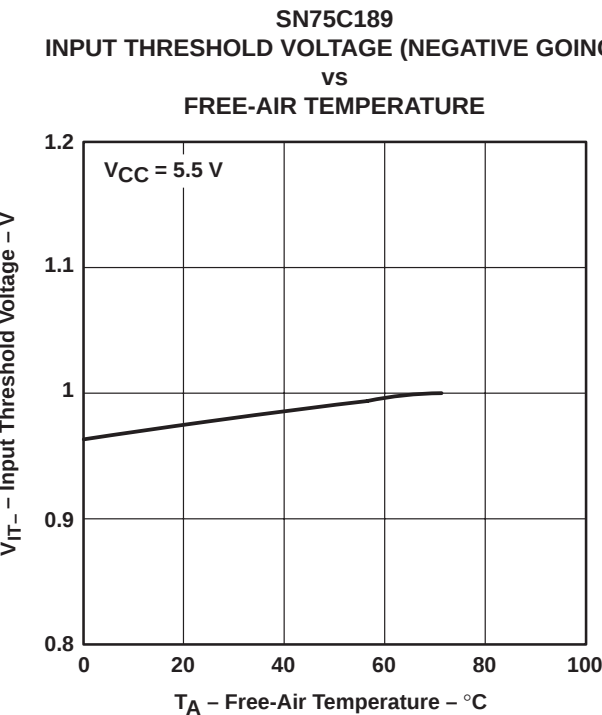


Figure 7

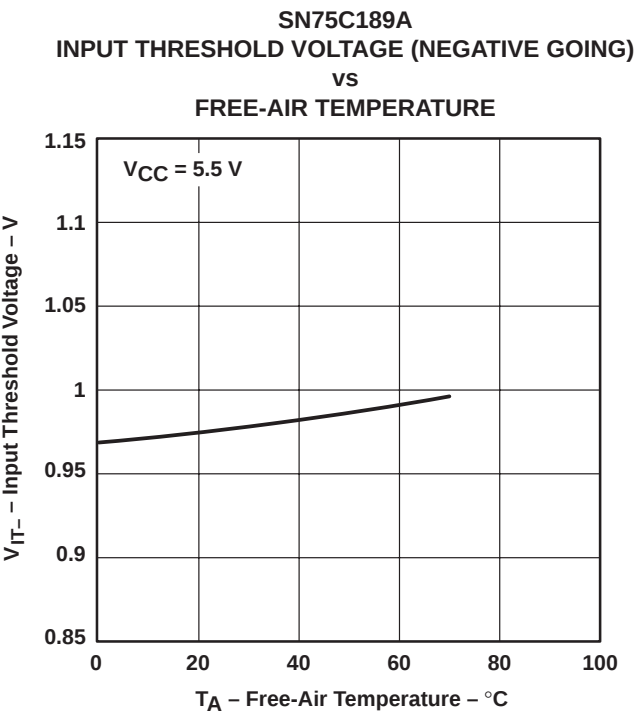


Figure 8

TYPICAL CHARACTERISTICS

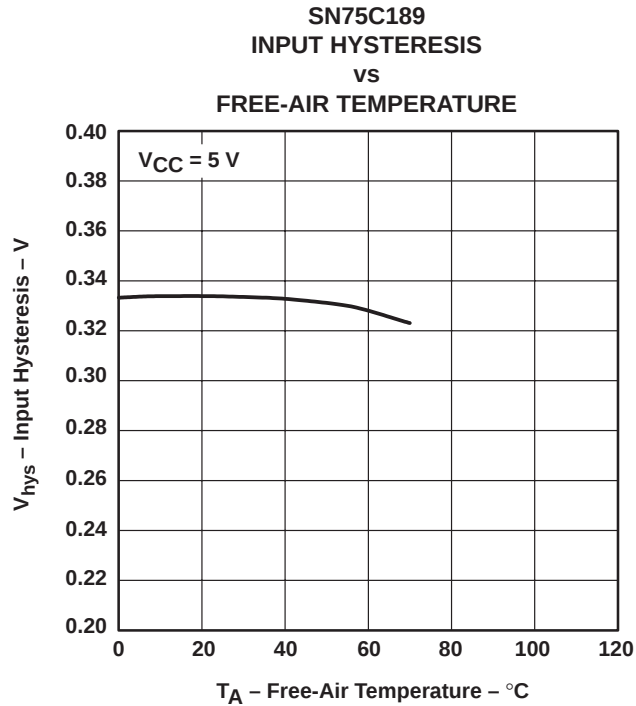


Figure 9

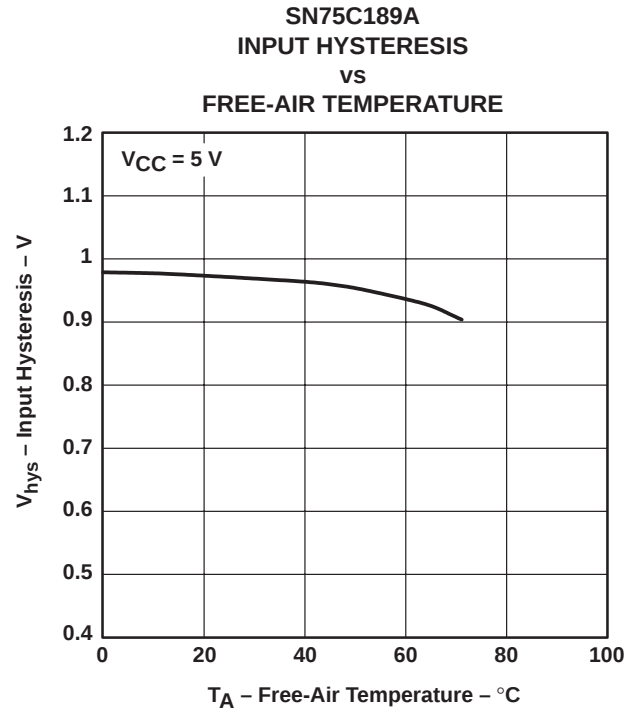


Figure 10

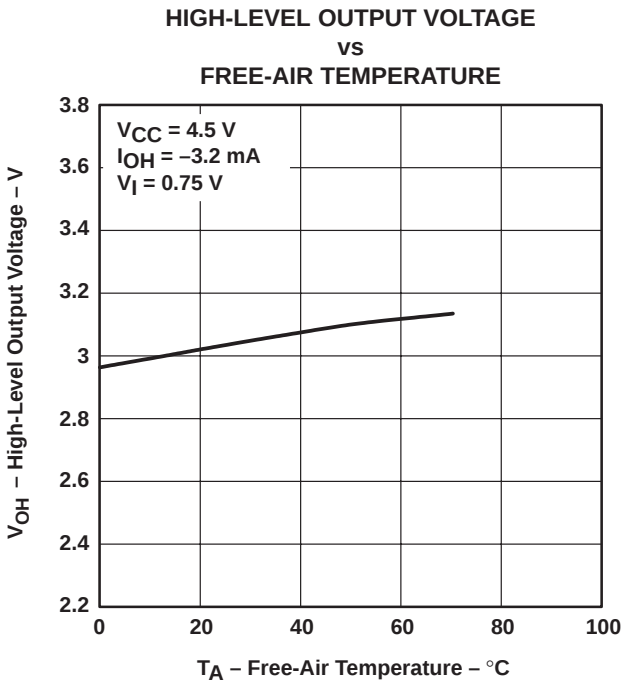


Figure 11

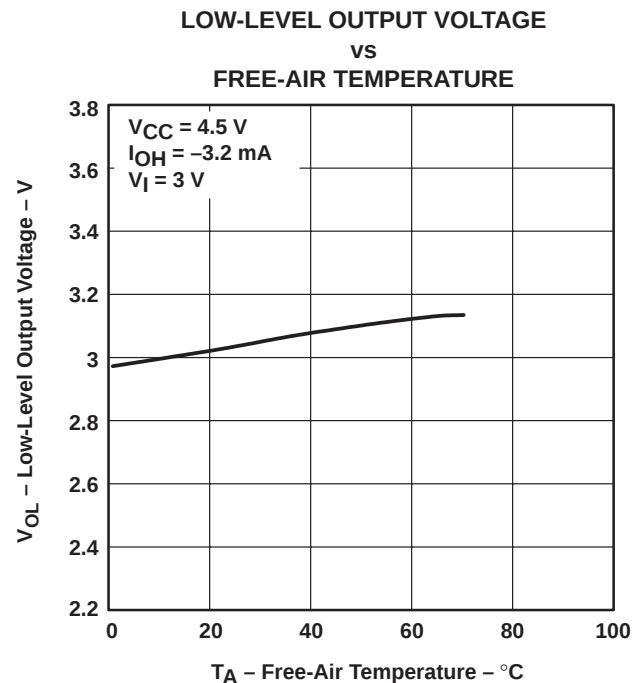


Figure 12

SN75C189, SN75C189A  
QUADRUPLE LOW-POWER LINE RECEIVERS

SLLS041G – OCTOBER 1988 – REVISED JANUARY 2000

TYPICAL CHARACTERISTICS

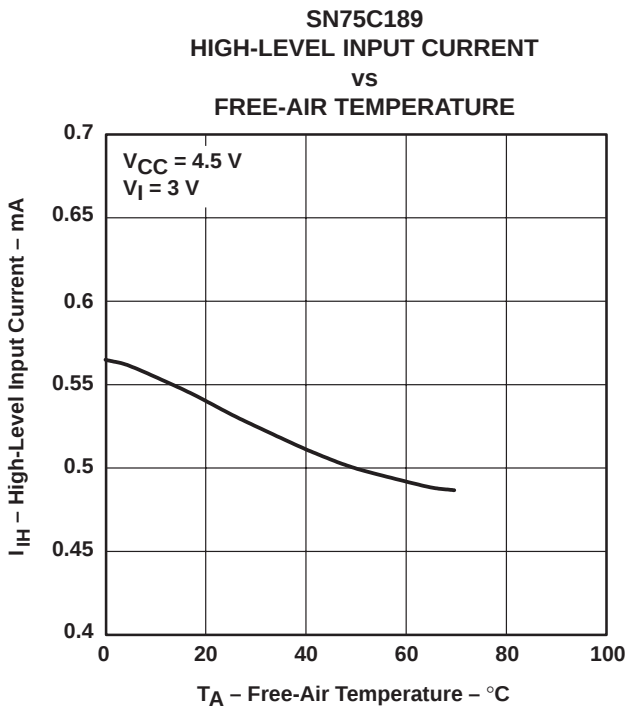


Figure 13

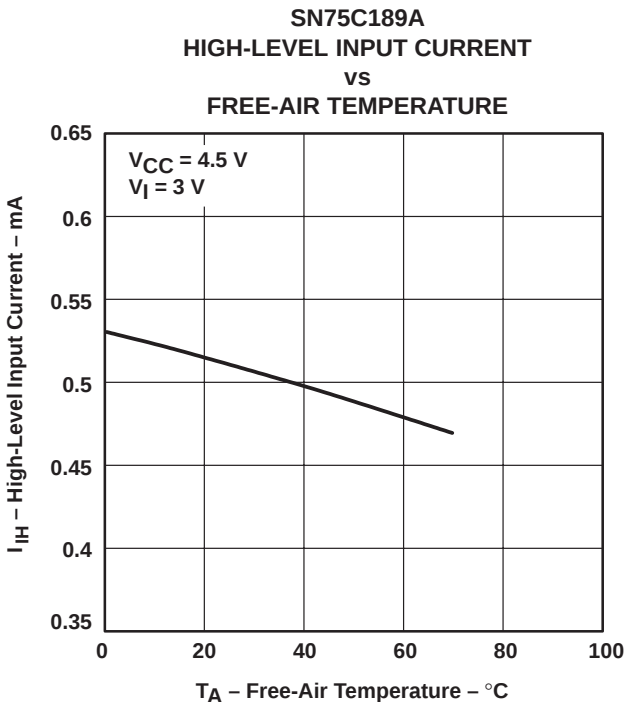


Figure 14

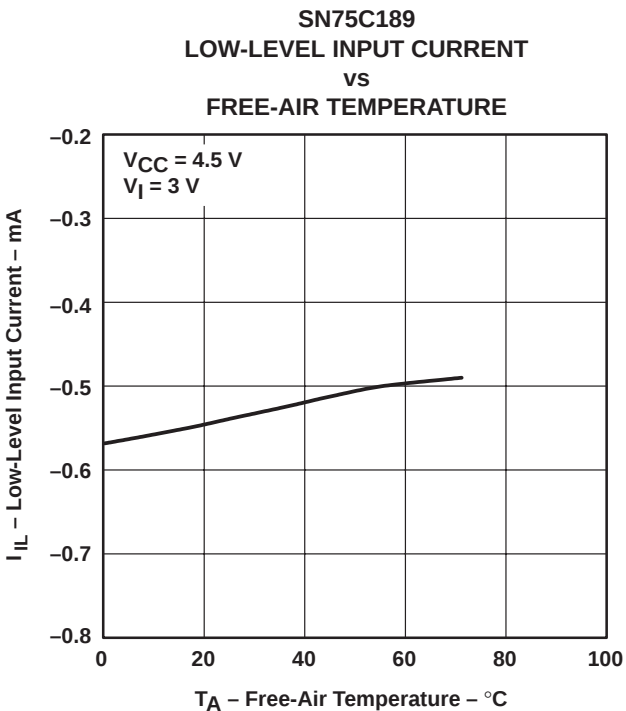


Figure 15

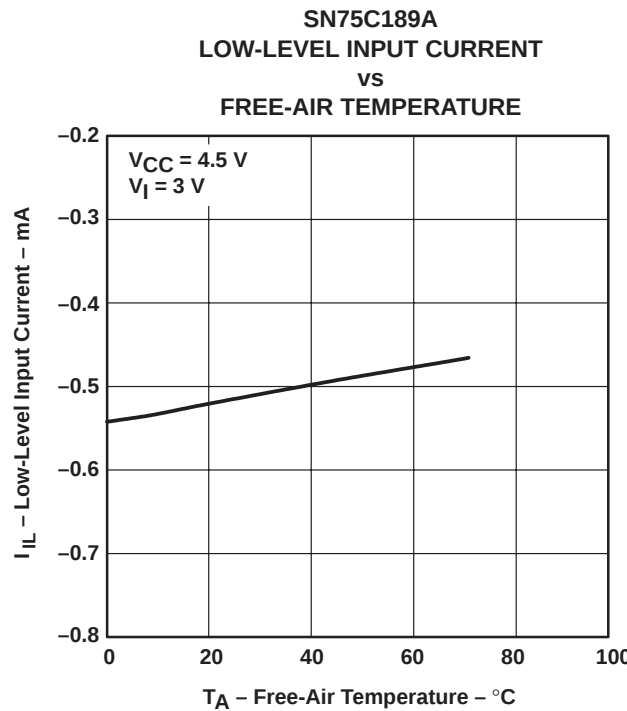


Figure 16

TYPICAL CHARACTERISTICS

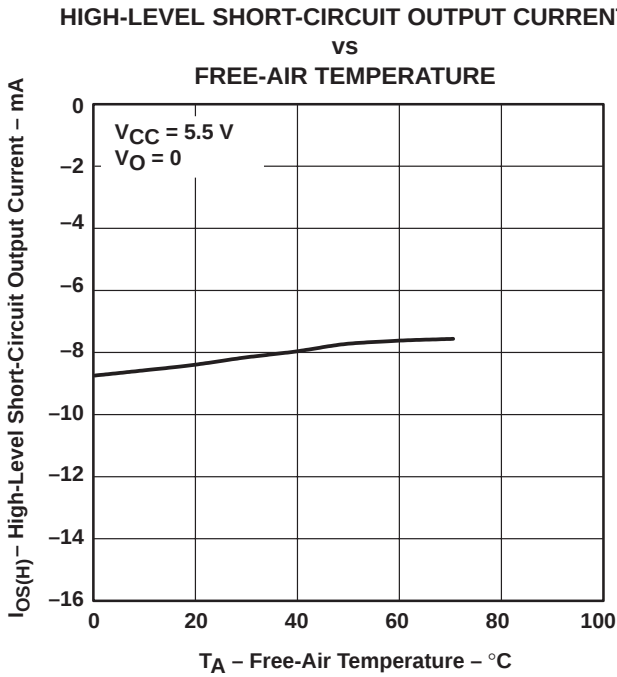


Figure 17

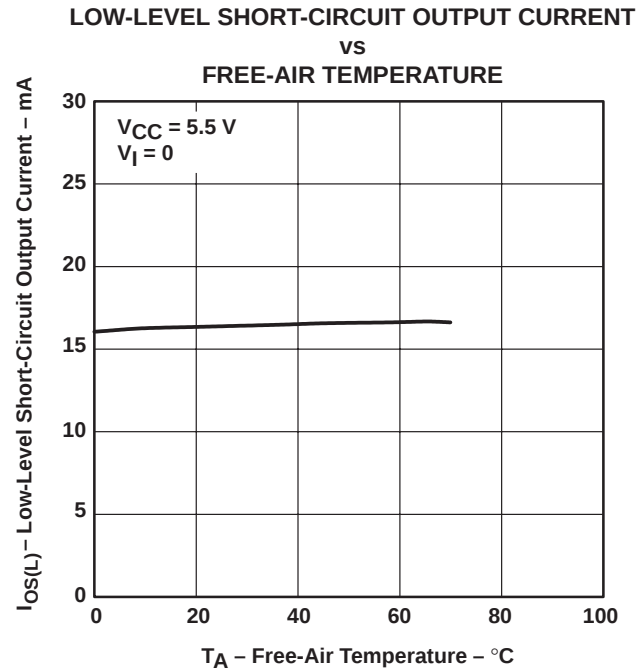


Figure 18

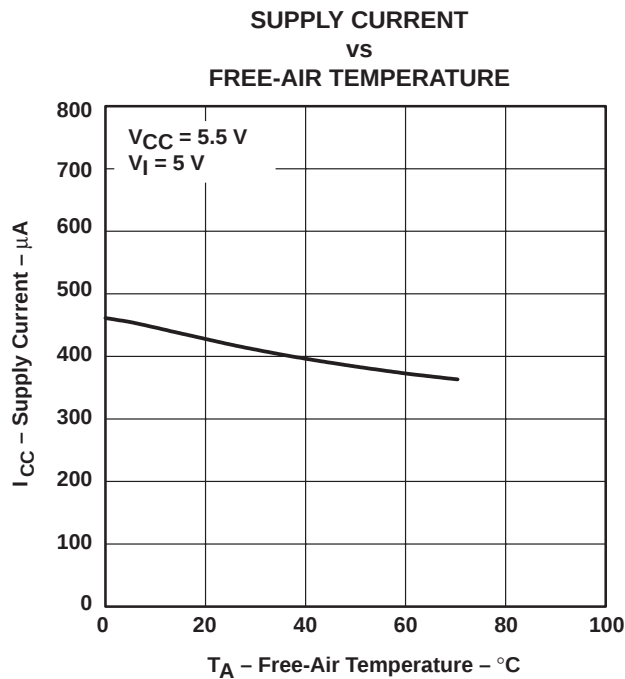


Figure 19

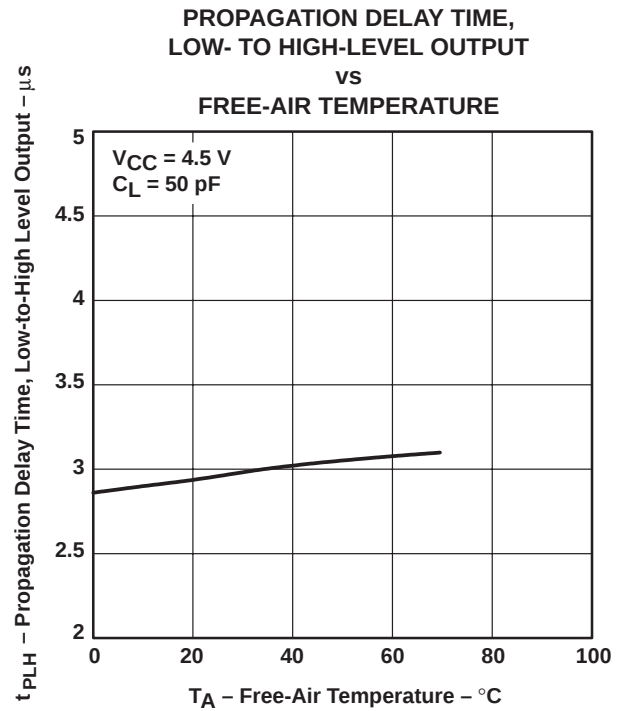


Figure 20

SN75C189, SN75C189A  
QUADRUPLE LOW-POWER LINE RECEIVERS

SLLS041G – OCTOBER 1988 – REVISED JANUARY 2000

TYPICAL CHARACTERISTICS

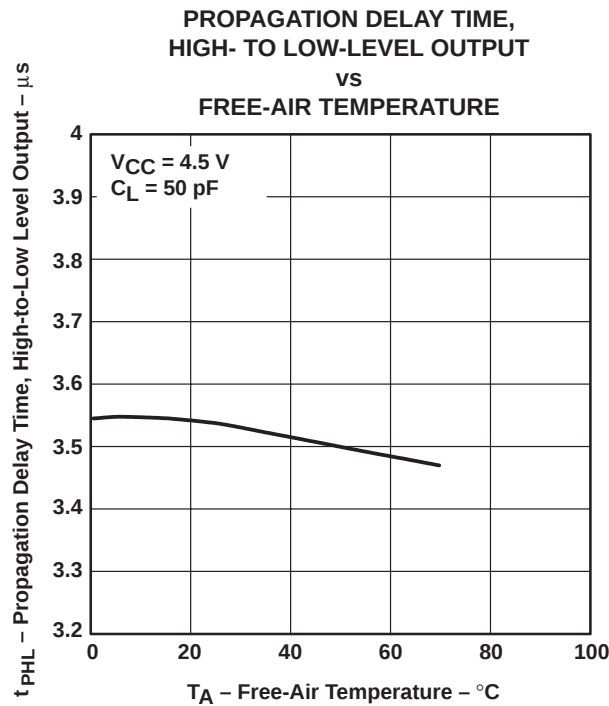


Figure 21

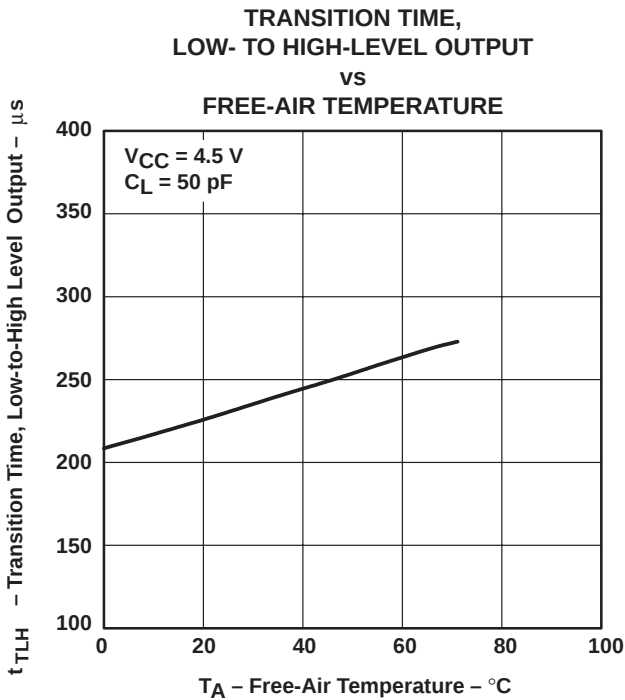


Figure 22

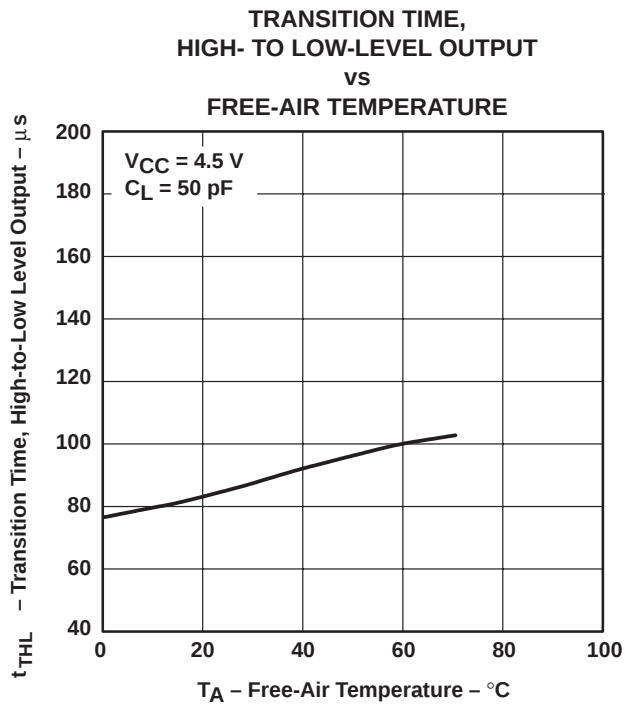


Figure 23

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN75C189AD</a>   | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 75C189A             |
| <a href="#">SN75C189ADBR</a> | Active        | Production           | SSOP (DB)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | CA189A              |
| SN75C189ADBR.A               | Active        | Production           | SSOP (DB)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | CA189A              |
| SN75C189ADBRE4               | Active        | Production           | SSOP (DB)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | CA189A              |
| <a href="#">SN75C189ADR</a>  | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C189A             |
| SN75C189ADR.A                | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C189A             |
| <a href="#">SN75C189AN</a>   | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN75C189AN          |
| SN75C189AN.A                 | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN75C189AN          |
| SN75C189ANE4                 | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN75C189AN          |
| <a href="#">SN75C189ANSR</a> | Active        | Production           | SOP (NS)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C189A             |
| SN75C189ANSR.A               | Active        | Production           | SOP (NS)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C189A             |
| <a href="#">SN75C189D</a>    | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | SN75C189            |
| <a href="#">SN75C189DR</a>   | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | SN75C189            |
| SN75C189DR.A                 | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | SN75C189            |
| SN75C189DRE4                 | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | SN75C189            |
| <a href="#">SN75C189N</a>    | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN75C189N           |
| SN75C189N.A                  | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | SN75C189N           |
| <a href="#">SN75C189NSR</a>  | Active        | Production           | SOP (NS)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C189              |
| SN75C189NSR.A                | Active        | Production           | SOP (NS)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C189              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN75C189ADBR | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| SN75C189ADR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN75C189ADR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN75C189ANSR | SOP          | NS              | 14   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| SN75C189DR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN75C189NSR  | SOP          | NS              | 14   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN75C189ADBR | SSOP         | DB              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN75C189ADR  | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN75C189ADR  | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN75C189ANSR | SOP          | NS              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN75C189DR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN75C189NSR  | SOP          | NS              | 14   | 2000 | 353.0       | 353.0      | 32.0        |

## TUBE



\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN75C189AN   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN75C189AN.A | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN75C189ANE4 | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN75C189N    | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN75C189N.A  | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



14/18 Pin Only  
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

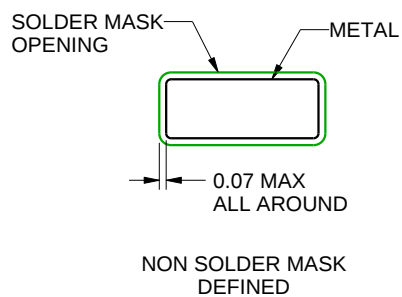
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

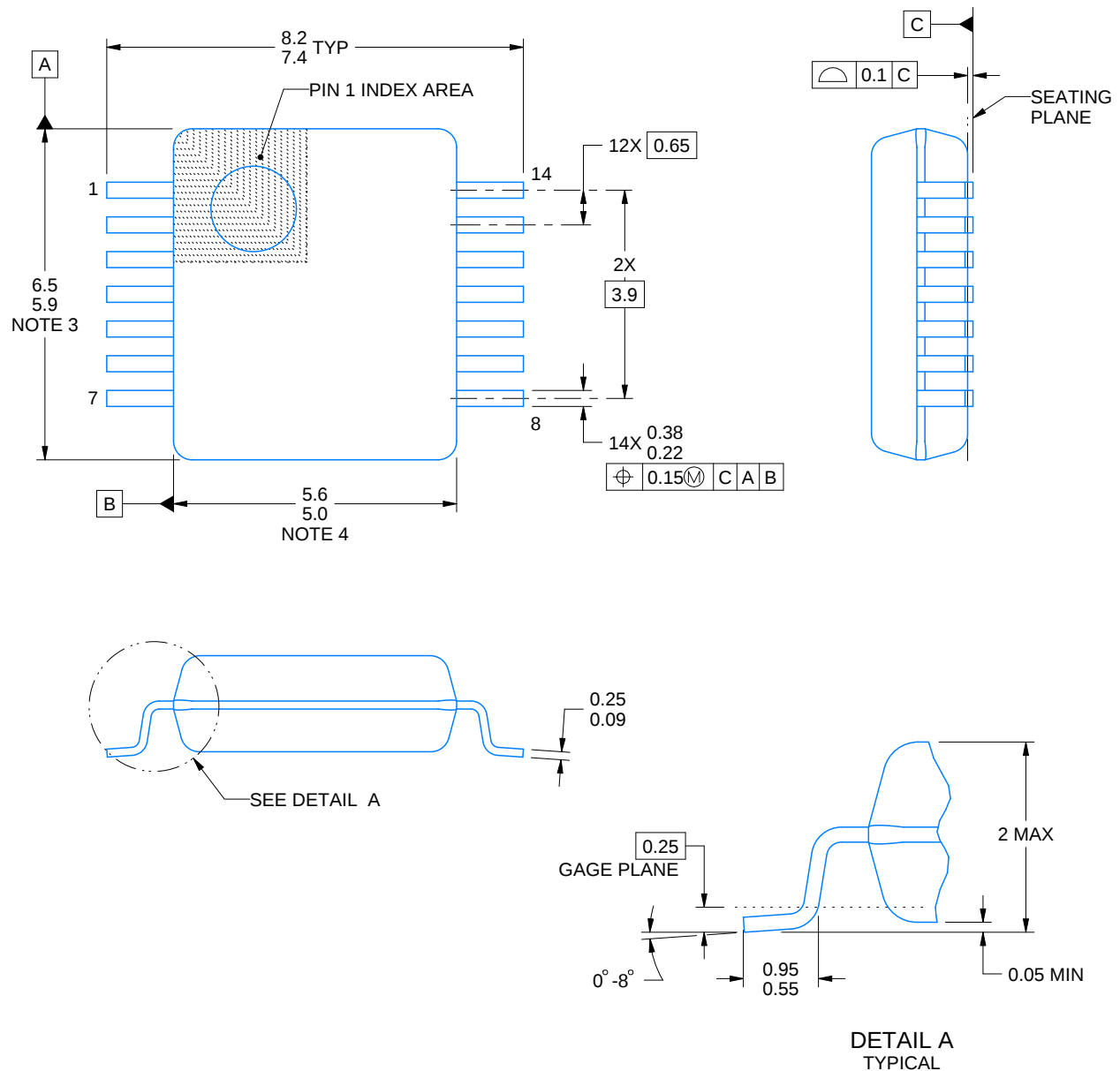
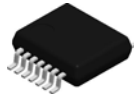
NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



4220762/A 05/2024

## NOTES:

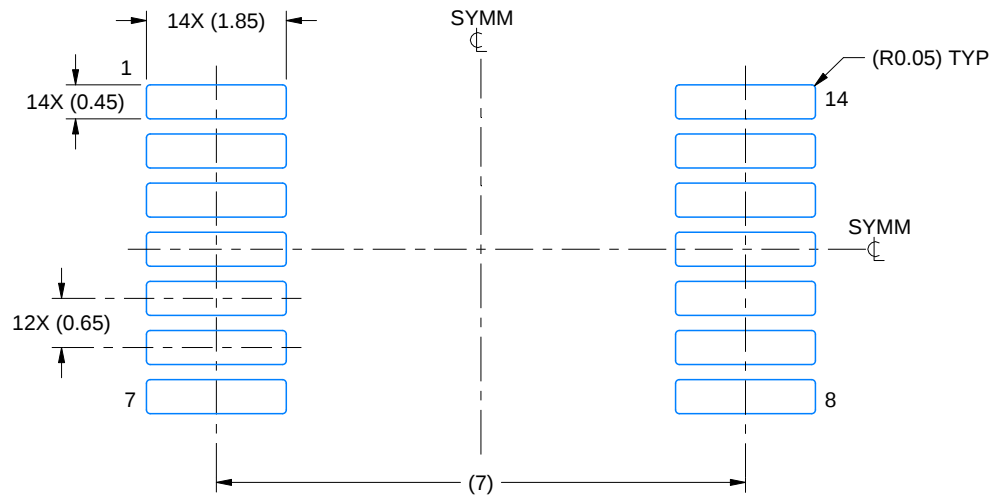
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

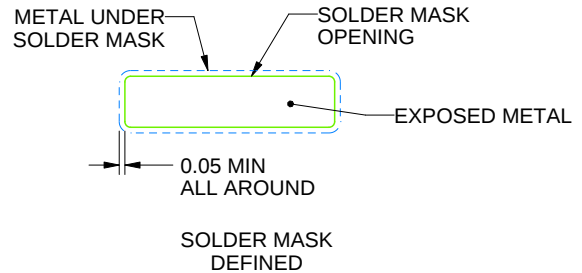
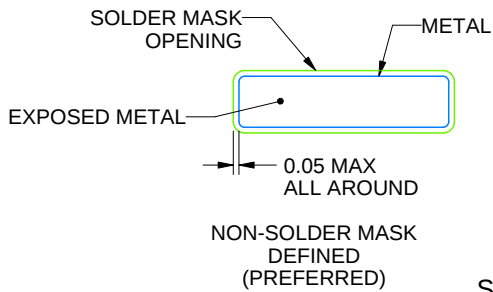
DB0014A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220762/A 05/2024

NOTES: (continued)

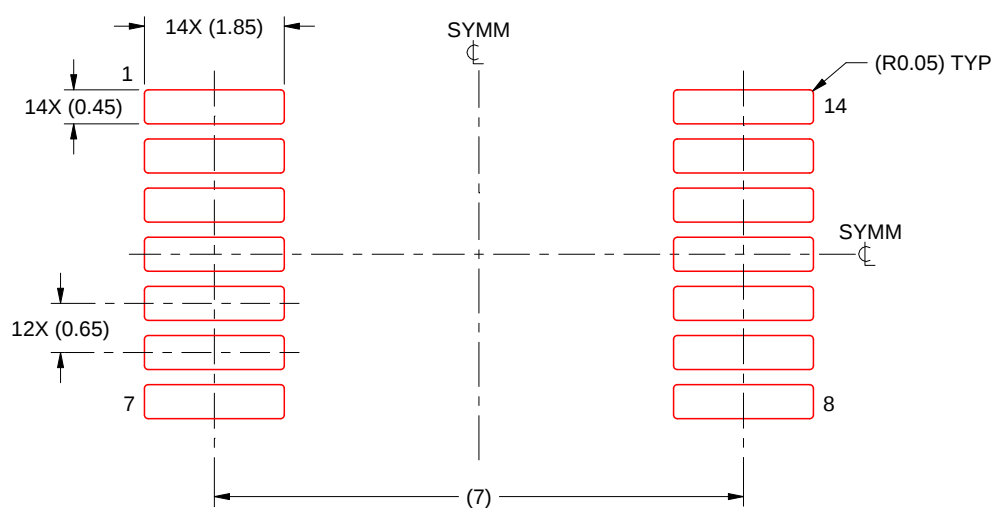
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DB0014A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220762/A 05/2024

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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